

256K x 16 (4-MBIT) DYNAMIC RAM WITH EDO PAGE MODE

FEATURES

- Extended Data-Out (EDO) Page Mode access cycle
- TTL compatible inputs and outputs; tristate I/O
- Refresh Interval: 512 cycles /8 ms
- Refresh Mode: RAS-Only, CAS-before-RAS (CBR), Hidden
- Single power supply:

5V ± 10% (IS41C16256)

 $3.3V \pm 10\%$ (IS41LV16256)

- Byte Write and Byte Read operation via two CAS
- Industrial Temperature Range -40°C to 85°C

DESCRIPTION

The *ICSI* IS41C16256 and IS41LV16256 is a 262,144 x 16-bit high-performance CMOS Dynamic Random Access Memories. The IS41C16256 offer an accelerated cycle access called EDO Page Mode. EDO Page Mode allows 512 random accesses within a single row with access cycle time as short as 10 ns per 16-bit word. The Byte Write control, of upper and lower byte, makes the IS41C16256 ideal for use in 16-, 32-bit wide data bus systems.

These features make the IS41C16256 and IS41LV16256 ideally suited for high-bandwidth graphics, digital signal processing, high-performance computing systems, and peripheral applications.

The IS41C16256 is packaged in a 40-pin 400mil SOJ and 400mil TSOP-2.

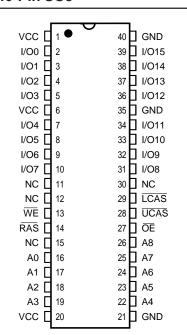
KEY TIMING PARAMETERS

Parameter	-25(5V)	-35	-50	-60	Unit	
Max. RAS Access Time (trac)	25	35	50	60	ns	
Max. CAS Access Time (tcac)	10	10	14	15	ns	
Max. Column Address Access Time (taa)	12	18	25	30	ns	
Min. EDO Page Mode Cycle Time (tpc)	10	12	20	25	ns	
Min. Read/Write Cycle Time (tRc)	45	60	90	110	ns	

PIN CONFIGURATIONS 40-Pin TSOP-2

vcc 🔲 40 GND I/O0 [39 I/O15 38 1/014 I/O1 🔲 37 1/013 1/02 🔲 4 36 1/012 I/O3 II 5 VCC 🔲 6 35 GND 1/04 🔲 7 34 1/011 33 1/010 1/05 1 8 32 1/09 1/06 🔲 9 I/O7 II 10 31 1/08 NC [11 30 NC NC 12 29 LCAS 28 UCAS 27 T ŌE RAS II 14 NC 15 26 🔲 A8 25 A7 A0 🔲 16 24 🔲 A6 A1 🔲 17 23 A5 A2 🔲 18 22 A4 A3 🔲 19 VCC 🔲 20 21 GND

40-Pin SOJ



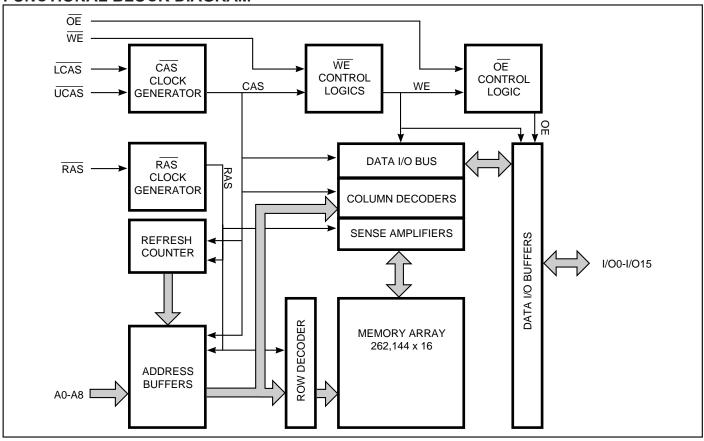
PIN DESCRIPTIONS

A0-A8	Address Inputs
I/O0-15	Data Inputs/Outputs
WE	Write Enable
ŌĒ	Output Enable
RAS	Row Address Strobe
UCAS	Upper Column Address Strobe
LCAS	Lower Column Address Strobe
Vcc	Power
GND	Ground
NC	No Connection
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FUNCTIONAL BLOCK DIAGRAM



IS41C16256 IS41LV16256



TRUTH TABLE

Function		RAS	LCAS	UCAS	WE	ŌĒ	Address tr/tc	I/O
Standby		Н	Н	Н	Х	Х	Χ	High-Z
Read: Word		L	L	L	Н	L	ROW/COL	Dout
Read: Lower Byte		L	L	Н	Н	L	ROW/COL	Lower Byte, Dout Upper Byte, High-Z
Read: Upper Byte		L	Н	L	Н	L	ROW/COL	Lower Byte, High-Z Upper Byte, Dout
Write: Word (Early Write)		L	L	L	L	Х	ROW/COL	Din
Write: Lower Byte (Early \	Vrite)	L	L	Н	L	Х	ROW/COL	Lower Byte, DIN Upper Byte, High-Z
Write: Upper Byte (Early \	Vrite)	L	Н	L	L	Х	ROW/COL	Lower Byte, High-Z Upper Byte, DIN
Read-Write ^(1,2)		L	L	L	H→L	L→H	ROW/COL	Dout, Din
EDO Page-Mode Read(2)	1st Cycle:	L	H→L	H→L	Н	L	ROW/COL	Dout
	2nd Cycle:	L	$H{ ightarrow} L$	$H{ ightarrow} L$	Н	L	NA/COL	Dout
	Any Cycle:	L	$L{\rightarrow}H$	$L \rightarrow H$	Н	L	NA/NA	Dout
EDO Page-Mode Write(1)	1st Cycle:	L	$H{ ightarrow} L$	$H{ ightarrow} L$	L	Χ	ROW/COL	DIN
	2nd Cycle:	L	$H{ ightarrow} L$	$H{ ightarrow} L$	L	Χ	NA/COL	DIN
EDO Page-Mode	1st Cycle:	L	H→L	H→L	H→L	L→H	ROW/COL	Dout, Din
Read-Write ^(1,2)	2nd Cycle:	L	$H{ ightarrow} L$	$H{ ightarrow} L$	$H{ ightarrow} L$	$L{\rightarrow}H$	NA/COL	DOUT, DIN
Hidden Refresh ⁽²⁾	Read I	\rightarrow H \rightarrow L	L	L	Н	L	ROW/COL	Dout
	Write I	\rightarrow H \rightarrow L	L	L	L	Χ	ROW/COL	Dout
RAS-Only Refresh		L	Н	Н	Χ	Х	ROW/NA	High-Z
CBR Refresh ⁽³⁾	·	$H{ ightarrow} L$	L	L	Χ	Χ	Χ	High-Z

- These WRITE cycles may also be BYTE WRITE cycles (either LCAS or UCAS active).
 These READ cycles may also be BYTE READ cycles (either LCAS or UCAS active).
 At least one of the two CAS signals must be active (LCAS or UCAS).



Functional Description

The IS41C16256 and IS41LV16256 is a CMOS DRAM optimized for high-speed bandwidth, low power applications. During READ or WRITE cycles, each bit is uniquely addressed through the 18 address bits. These are entered 9 bits (A0-A8) at a time. The row address is latched by the Row Address Strobe (RAS). The column address is latched by the Column Address Strobe (CAS). RAS is used to latch the first nine bits and CAS is used the latter nine bits.

The IS41C16256 and IS41LV16256 has two CAS controls, LCAS and UCAS. The LCAS and UCAS inputs internally generates a CAS signal functioning in an identical manner to the single CAS input on the other 256K x 16 DRAMs. The key difference is that each CAS controls its corresponding I/O tristate logic (in conjunction with OE and WE and RAS). LCAS controls I/O0 through I/O7 and UCAS controls I/O8 through I/O15.

The IS41C16256 and IS41LV16256 CAS function is determined by the first CAS (LCAS or UCAS) transitioning LOW and the last transitioning back HIGH. The two CAS controls give the IS41C16256 both BYTE READ and BYTE WRITE cycle capabilities.

Memory Cycle

A memory cycle is initiated by <u>bring RAS LOW</u> and it is terminated by returning both RAS and CAS HIGH. To ensures proper device operation and data integrity any memory cycle, once initiated, must not be ended or aborted before the minimum tras time has expired. A new cycle must not be initiated until the minimum precharge time trp, tcp has elapsed.

Read Cycle

A read cycle is initiated by the falling edge of CAS or OE, whichever occurs last, while holding WE HIGH. The column address must be held for a minimum time specified by tar. Data Out becomes valid only when trac, taa, tcac and toea are all satisfied. As a result, the access time is dependent on the timing relationships between these parameters.

Write Cycle

A write cycle is initiated by the falling edge of \overline{CAS} and \overline{WE} , whichever occurs last. The input data must be valid at or before the falling edge of \overline{CAS} or \overline{WE} , whichever occurs first.

Refresh Cycle

To retain data, 512 refresh cycles are required in each 8 ms period. There are two ways to refresh the memory.

- By clocking each of the 512 row addresses (A0 through A8) with RAS at least once every 8 ms. Any read, write, read-modify-write or RAS-only cycle refreshes the addressed row.
- Using a CAS-before-RAS refresh cycle. CAS-before-RAS refresh is activated by the falling edge of RAS, while holding CAS LOW. In CAS-before-RAS refresh cycle, an internal 9-bit counter provides the row addresses and the external address inputs are ignored.

CAS-before-RAS is a refresh-only mode and no data access or device selection is allowed. Thus, the output remains in the High-Z state during the cycle.

Extended Data Out Page Mode

EDO page mode operation permits all 512 columns within a selected row to be randomly accessed at a high data rate.

In EDO page mode read cycle, the data-out is held to the next CAS cycle's falling edge, instead of the rising edge. For this reason, the valid data output time in EDO page mode is extended compared with the fast page mode. In the fast page mode, the valid data output time becomes shorter as the CAS cycle time becomes shorter. Therefore, in EDO page mode, the timing margin in read cycle is larger than that of the fast page mode even if the CAS cycle time becomes shorter.

 $\overline{\text{Ln EDO}}$ page mode, due to the extended data function, the $\overline{\text{CAS}}$ cycle time can be shorter than in the fast page mode if the timing margin is the same.

The EDO page mode allows both read and write operations during one RAS cycle, but the performance is equivalent to that of the fast page mode in that case.

Power-On

After application of the Vcc supply, an initial pause of 200 µs is required followed by a minimum of eight initialization cycles (any combination of cycles containing a RAS signal).

During power-on, it is recommended that \overline{RAS} track with Vcc or be held at a valid VIH to avoid current surges.



ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Parameters		Rating	Unit
VT	Voltage on Any Pin Relative to GND	5V	-1.0 to +7.0	V
		3.3V	-0.5 to +4.6	
Vcc	Supply Voltage	5V	-1.0 to +7.0	V
		3.3V	-0.5 to +4.6	
Іоит	Output Current		50	mA
Po	Power Dissipation		1	W
TA	Commercial Operation Temperature		0 to +70	°C
	Industrial Operationg Temperature		-40 to +85	°C
Тѕтс	Storage Temperature		-55 to +125	°C

Note:

RECOMMENDED OPERATING CONDITIONS (Voltages are referenced to GND.)

Symbol	Parameter		Min.	Тур.	Max.	Unit
Vcc	Supply Voltage	5V	4.5	5.0	5.5	V
		3.3V	3.0	3.3	3.6	
VIH	Input High Voltage	5V	2.4	_	Vcc + 1.0	V
		3.3V	2.0		Vcc + 0.3	
VIL	Input Low Voltage	5V	-1.0	_	0.8	V
		3.3V	-0.3	_	8.0	
ТА	Commercial Ambient Temperature		0	_	70	°C
	Industrial Ambient Temperature		-40	_	85	°C

CAPACITANCE(1,2)

Symbol	Parameter	Max.	Unit
CIN1	Input Capacitance: A0-A8	5	pF
CIN2	Input Capacitance: RAS, UCAS, LCAS, WE, OE	7	pF
Сю	Data Input/Output Capacitance: I/O0-I/O15	7	pF

- 1. Tested initially and after any design or process changes that may affect these parameters.
- 2. Test conditions: T_A = 25°C, f = 1 MHz.

Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.



ELECTRICAL CHARACTERISTICS(1)

(Recommended Operating Conditions unless otherwise noted.)

Symbol	Parameter	Test Condition		Speed	Min.	Max.	Unit
lι∟	Input Leakage Current	Any input 0V < VIN < Vcc Other inputs not under tes	st = 0V		-10	10	μA
lio	Output Leakage Current	Output is disabled (Hi-Z) 0V < Vout < Vcc			-10	10	μA
Vон	Output High Voltage Level	lон = −2.5 mA			2.4	_	V
Vol	Output Low Voltage Level	IoL =+2.1mA			_	0.4	V
Icc1	Standby Current: TTL	RAS, LCAS, UCAS > VIH	Commerical Industrial Commerical Industrial	5V 5V 3.3V 3.3V	_ _ _	2 3 1 2	mA
Icc2	Standby Current: CMOS	RAS, LCAS, UCAS > Vcc	- 0.2V	5V 3.3V	_	1 0.5	mA
Icc3	Operating Current: Random Read/Write ^(2,3,4) Average Power Supply Current	RAS, LCAS, UCAS, Address Cycling, trc = tro	c (min.)	-25 -35 -50 -60	_ _ _	260 230 180 170	mA
lcc4	Operating Current: EDO Page Mode ^(2,3,4) Average Power Supply Current	RAS = VIL, LCAS, UCAS, Cycling tpc = tpc (min.)		-25 -35 -50 -60	_ _ _	250 220 170 160	mA
Icc5	Refresh Current: RAS-Only ^(2,3) Average Power Supply Current	RAS Cycling, LCAS, UCA trc = trc (min.)	S > VIH	-25 -35 -50 -60	_ _ _	260 230 180 170	mA
Icc6	Refresh Current: CBR ^(2,3,5) Average Power Supply Current	RAS, LCAS, UCAS Cyclin trc = trc (min.)	g	-25 -35 -50 -60	_ _ _	260 230 180 170	mA

^{1.} An initial pause of 200 µs is required after power-up followed by eight \overline{AAS} refresh cycles (\overline{RAS} -Only or CBR) before proper device operation is assured. The eight \overline{RAS} cycles wake-up should be repeated any time the tree refresh requirement is exceeded.

^{2.} Dependent on cycle rates.

^{3.} Specified values are obtained with minimum cycle time and the output open.

^{4.} Column-address is changed once each EDO page cycle.

^{5.} Enables on-chip refresh and address counters.



AC CHARACTERISTICS(1,2,3,4,5,6)

(Recommended Operating Conditions unless otherwise noted.)

		-2	25	-;	35	-:	50	-(60	
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Units
trc	Random READ or WRITE Cycle Time	45	_	60	_	90	_	110		ns
trac	Access Time from RAS(6, 7)		25	_	35	_	50	_	60	ns
tcac	Access Time from CAS(6, 8, 15)	_	10	_	10	_	14	_	15	ns
t AA	Access Time from Column-Address ⁽⁶⁾	_	12	_	18		25	_	30	ns
tras	RAS Pulse Width	25	10K	35	10K	50	10K	60	10K	ns
trp	RAS Precharge Time	15	_	20	_	30	_	40	_	ns
tcas	CAS Pulse Width ⁽²⁶⁾	4	10K	6	10K	8	10K	10	10K	ns
tcp	CAS Precharge Time ^(9, 25)	4	_	5	_	8	_	10	_	ns
tcsн	CAS Hold Time (21)	25	_	35	_	50	_	60	_	ns
trcd	RAS to CAS Delay Time(10, 20)	10	17	11	28	19	36	20	45	ns
tasr	Row-Address Setup Time	0	_	0	_	0	_	0	_	ns
trah	Row-Address Hold Time	6	_	6	_	8	_	10	_	ns
tasc	Column-Address Setup Time(20)	0		0		0		0	_	ns
t CAH	Column-Address Hold Time(20)	5		6		8		10	_	ns
tar	Column-Address Hold Time (referenced to RAS)	19	_	30	_	40	_	40	_	ns
trad	RAS to Column-Address Delay Time(11)	8	20	10	20	14	25	15	30	ns
tral	Column-Address to RAS Lead Time	12	_	18	_	25	_	30	_	ns
trpc	RAS to CAS Precharge Time	0		0	_	0	_	0	_	ns
trsh	RAS Hold Time(27)	7	_	8	_	14	_	15	_	ns
tclz	CAS to Output in Low-Z ^(15, 29)	3	_	3	_	3	_	3	_	ns
tcrp	CAS to RAS Precharge Time(21)	5	_	5	_	5	_	5	_	ns
top	Output Disable Time(19, 28, 29)	2	12	3	12	3	12	3	12	ns
toe	Output Enable Time(15, 16)	0	8	0	10	0	15	_	15	ns
toehc	OE HIGH Hold Time from CAS HIGH	10	_	10	_	10		10	_	ns
toep	OE HIGH Pulse Width	10		10	_	10		10	_	ns
toes	OE LOW to CAS HIGH Setup Time	5	_	5	_	5	_	5	_	ns
trcs	Read Command Setup Time(17, 20)	0	_	0	_	0		0	_	ns
trrh	Read Command Hold Time (referenced to RAS)(12)	0	_	0	_	0	_	0	_	ns
trch	Read Command Hold Time (referenced to CAS)(12, 17, 21)	0	_	0	_	0	_	0	_	ns
twch	Write Command Hold Time(17, 27)	5		5	_	8	_	10		ns
twcr	Write Command Hold Time (referenced to RAS)(17)	19	_	30	_	40	_	50	_	ns
twp	Write Command Pulse Width(17)	5	_	5	_	8	_	10	_	ns
twpz	WE Pulse Widths to Disable Outputs	10	_	10	_	10	_	10		ns
trwl	Write Command to RAS Lead Time(17)	7	_	8	_	14		15		ns
tcwL	Write Command to CAS Lead Time(17, 21)	5		8	_	14		15		ns
twcs	Write Command Setup Time(14, 17, 20)	0		0		0		0		ns
	Data-in Hold Time (referenced to RAS)	19	_	30		40		40		ns



AC CHARACTERISTICS (Continued)(1,2,3,4,5,6)

(Recommended Operating Conditions unless otherwise noted.)

		-2	25	_;	35	-4	50	-(60	_
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Units
tach	Column-Address Setup Time to CAS Precharge during WRITE Cycle		_	15	_	15	_	15	_	ns
tоен	OE Hold Time from WE during READ-MODIFY-WRITE cycle ⁽¹⁸⁾		_	8	_	10	_	15	_	ns
tos	Data-In Setup Time(15, 22)	0	_	0		0		0	_	ns
tdh	Data-In Hold Time(15, 22)	5	_	6	_	8		10	_	ns
trwc	READ-MODIFY-WRITE Cycle Time	65	_	80	_	125	_	140	_	ns
trwd	RAS to WE Delay Time during READ-MODIFY-WRITE Cycle ⁽¹⁴⁾	35	_	45	_	70	_	80	_	ns
tcwd	CAS to WE Delay Time(14, 20)	17	_	25		34		36	_	ns
tawd	Column-Address to WE Delay Time(14)	21	_	30	_	42	_	49	_	ns
tpc	EDO Page Mode READ or WRITE Cycle Time ⁽²⁴⁾	10	_	12	_	20	_	25	_	ns
trasp	RAS Pulse Width in EDO Page Mode	25	100K	35	100K	50	100K	50	100K	ns
t CPA	Access Time from CAS Precharge ⁽¹⁵⁾	_	14	_	21	_	27	_	34	ns
tprwc	EDO Page Mode READ-WRITE Cycle Time ⁽²⁴⁾	32	_	40	_	47	_	56	_	ns
tсон	Data Output Hold after CAS LOW	5	_	5	_	5	_	5	_	ns
toff	Output Buffer Turn-Off Delay from CAS or RAS (13,15,19,29)	3	15	3	15	3	15	3	15	ns
twnz	Output Disable Delay from WE	3	15	3	15	3	15	3	15	ns
tclch	Last CAS going LOW to First CAS returning HIGH ⁽²³⁾	10	_	10	_	10	_	10	_	ns
tcsr	CAS Setup Time (CBR REFRESH)(30, 20)	5	_	8	_	10	_	10	_	ns
tchr	CAS Hold Time (CBR REFRESH)(30, 21)	7	_	8	_	10	_	10	_	ns
tord	OE Setup Time prior to RAS during HIDDEN REFRESH Cycle	0	_	0	_	0	_	0	_	ns
tref	Refresh Period (512 Cycles)	_	8	_	8	_	8	_	8	ms
tτ	Transition Time (Rise or Fall)(2, 3)	1	50	1	50	1	50	1	50	ns

AC TEST CONDITIONS

Output load: Two TTL Loads and 50 pF ($Vcc = 5.0V \pm 10\%$)

One TTL Load and 50 pF ($Vcc = 3.3V \pm 10\%$)

Input timing reference levels: $V_{IH} = 2.4V$, $V_{IL} = 0.8V$ ($V_{CC} = 5.0V \pm 10\%$);

 $V_{IH} = 2.0V$, $V_{IL} = 0.8V$ ($V_{CC} = 3.3V \pm 10\%$)

Output timing reference levels: VOH = 2.0V, VOL = 0.8V ($VCC = 5V \pm 10\%$, $3.3V \pm 10\%$)

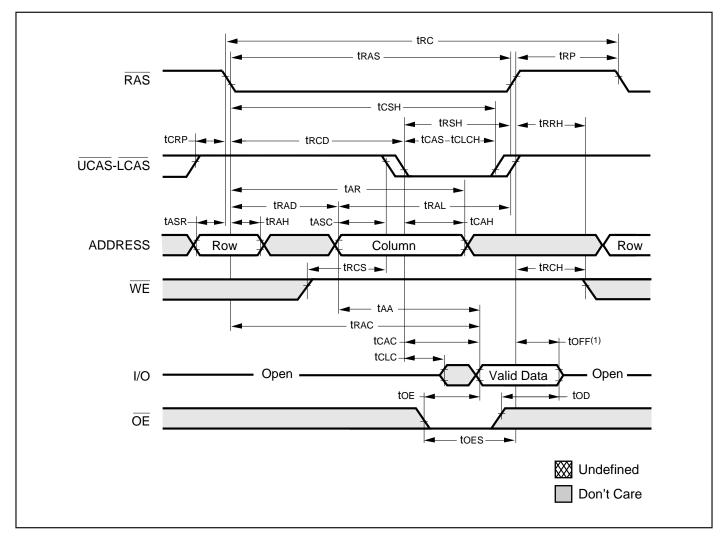
IS41C16256 IS41LV16256



- 1. An initial pause of 200 µs is required after power-up followed by eight RAS refresh cycle (RAS-Only or CBR) before proper device operation is assured. The eight RAS cycles wake-up should be repeated any time the tree refresh requirement is exceeded.
- 2. Vih (MIN) and Vil (MAX) are reference levels for measuring timing of input signals. Transition times, are measured between Vih and Vil (or between Vil and Vih) and assume to be 1 ns for all inputs.
- 3. In addition to meeting the transition rate specification, all input signals must transit between V_IH and V_IL (or between V_IL and V_IH) in a monotonic manner.
- 4. If \overline{CAS} and $\overline{RAS} = V_{IH}$, data output is High-Z.
- 5. If $\overline{CAS} = V_{IL}$, data output may contain data from the last valid READ cycle.
- 6. Measured with a load equivalent to one TTL gate and 50 pF.
- 7. Assumes that tRCD ≤ tRCD (MAX). If tRCD is greater than the maximum recommended value shown in this table, tRAC will increase by the amount that tRCD exceeds the value shown.
- 8. Assumes that $trcp \ge trcp$ (MAX).
- 9. If CAS is LOW at the falling edge of RAS, data out will be maintained from the previous cycle. To initiate a new cycle and clear the data output buffer, CAS and RAS must be pulsed for tcp.
- 10. Operation with the trcd (MAX) limit ensures that trac (MAX) can be met. trcd (MAX) is specified as a reference point only; if trcd is greater than the specified trcd (MAX) limit, access time is controlled exclusively by trac.
- 11. Operation within the trad (MAX) limit ensures that trad (MAX) can be met. trad (MAX) is specified as a reference point only; if trad is greater than the specified trad (MAX) limit, access time is controlled exclusively by trad.
- 12. Either trich or trich must be satisfied for a READ cycle.
- 13. toff (MAX) defines the time at which the output achieves the open circuit condition; it is not a reference to Voh or Vol.
- 14. twcs, trwb, tawb and tcwb are restrictive operating parameters in LATE WRITE and READ-MODIFY-WRITE cycle only. If twcs ≥ twcs (MIN), the cycle is an EARLY WRITE cycle and the data output will remain open circuit throughout the entire cycle. If trwb ≥ trwb (MIN), tawb ≥ tawb (MIN) and tcwb ≥ tcwb (MIN), the cycle is a READ-WRITE cycle and the data output will contain data read from the selected cell. If neither of the above conditions is met, the state of I/O (at access time and until CAS and RAS or OE go back to Vih) is indeterminate. OE held HIGH and WE taken LOW after CAS goes LOW result in a LATE WRITE (OE-controlled) cycle.
- 15. Output parameter (I/O) is referenced to corresponding CAS input, I/O0-I/O7 by LCAS and I/O8-I/O15 by UCAS.
- 16. During a READ cycle, if \overline{OE} is LOW then taken HIGH before \overline{CAS} goes HIGH, I/O goes open. If \overline{OE} is tied permanently LOW, a LATE WRITE or READ-MODIFY-WRITE is not possible.
- 17. Write command is defined as $\overline{\text{WE}}$ going low.
- 18. LATE WRITE and READ-MODIFY-WRITE cycles must have both top and toeh met (OE HIGH during WRITE cycle) in order to ensure that the output buffers will be open during the WRITE cycle. The I/Os will provide the previously written data if CAS remains LOW and OE is taken back to LOW after toeh is met.
- 19. The I/Os are in open during READ cycles once too or toff occur.
- 20. The first $\chi \overline{\text{CAS}}$ edge to transition LOW.
- 21. The last $\chi \overline{\text{CAS}}$ edge to transition HIGH.
- 22. These parameters are referenced to $\overline{\text{CAS}}$ leading edge in EARLY WRITE cycles and $\overline{\text{WE}}$ leading edge in LATE WRITE or READ-MODIFY-WRITE cycles.
- 23. Last falling $\chi \overline{CAS}$ edge to first rising $\chi \overline{CAS}$ edge.
- 24. Last rising $\chi \overline{CAS}$ edge to next cycle's last rising $\chi \overline{CAS}$ edge.
- 25. Last rising $\chi \overline{CAS}$ edge to first falling $\chi \overline{CAS}$ edge.
- 26. Each $\chi \overline{CAS}$ must meet minimum pulse width.
- 27. Last $\chi \overline{CAS}$ to go LOW.
- 28. I/Os controlled, regardless UCAS and LCAS.
- 29. The 3 ns minimum is a parameter guaranteed by design.
- 30. Enables on-chip refresh and address counters.



READ CYCLE

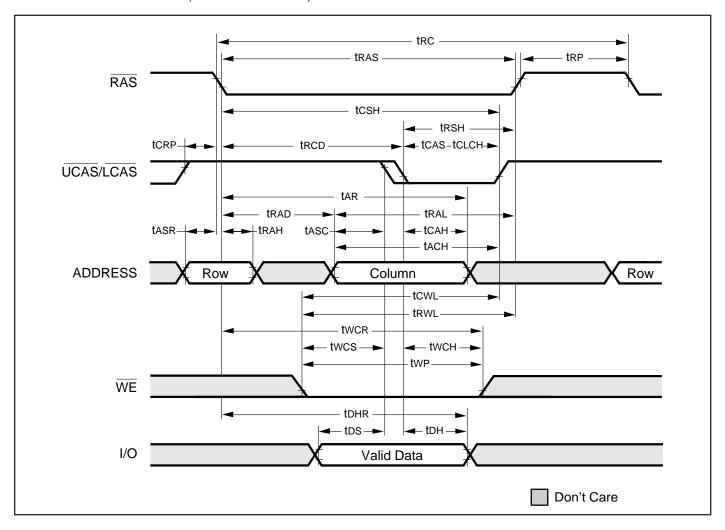


Note:

1. toff is referenced from rising edge of \overline{RAS} or \overline{CAS} , whichever occurs last.

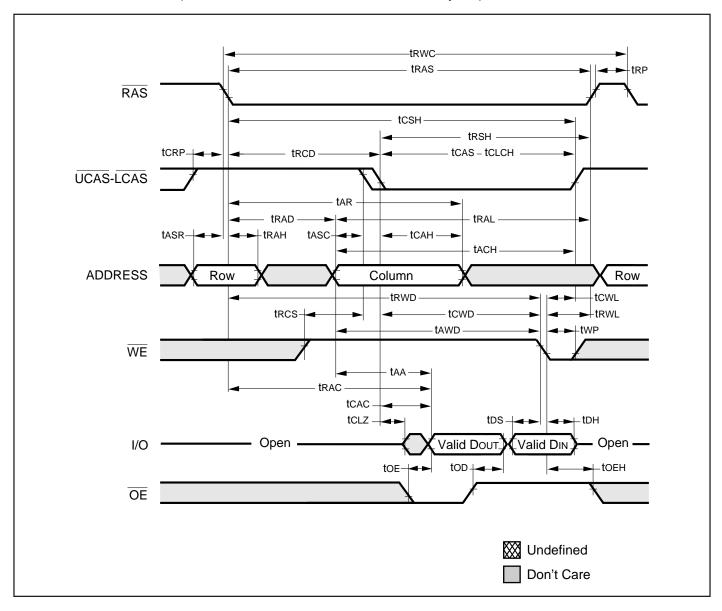


EARLY WRITE CYCLE (OE = DON'T CARE)



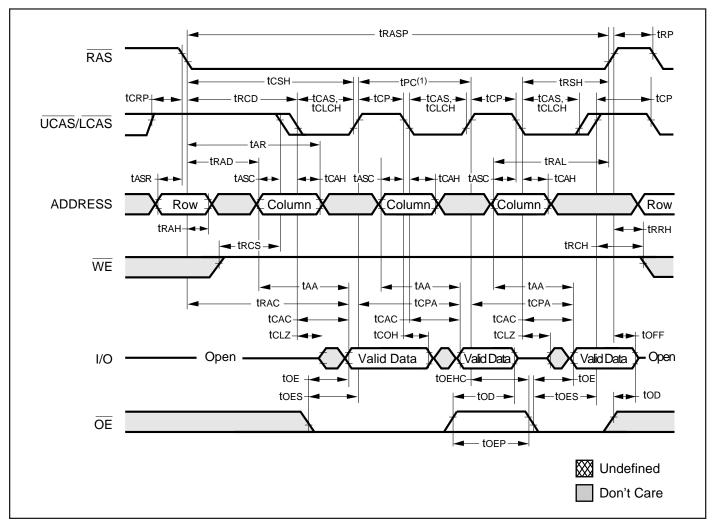


READ WRITE CYCLE (LATE WRITE and READ-MODIFY-WRITE Cycles)





EDO-PAGE-MODE READ CYCLE

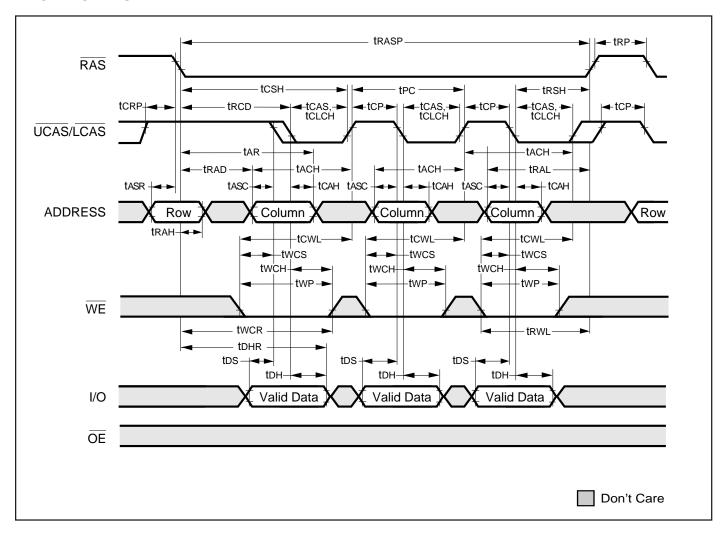


Note:

1. tPC can be measured from falling edge of CAS to falling edge of CAS, or from rising edge of CAS to rising edge of CAS. Both measurements must meet the tPC specifications.

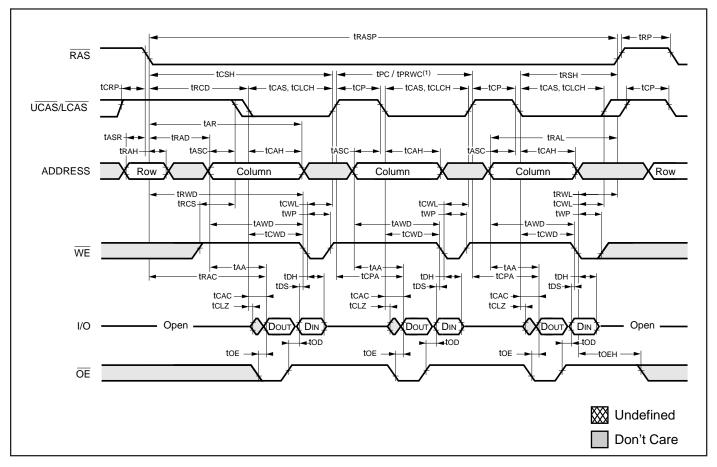


EDO-PAGE-MODE EARLY-WRITE CYCLE





EDO-PAGE-MODE READ-WRITE CYCLE (LATE WRITE and READ-MODIFY WRITE Cycles)

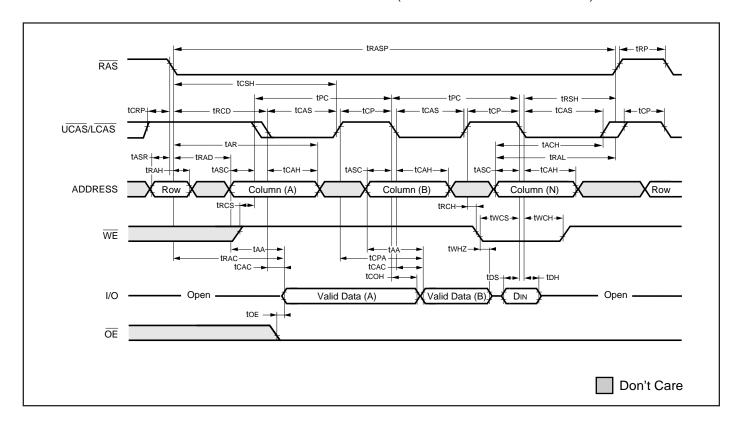


Note:

1. trc in this diagram is for LATE write cycles only, trc can be measured from falling edge of CAS to falling edge of CAS, or from rising edge of CAS to rising edge of CAS. Both measurements must meet the trc specifications.



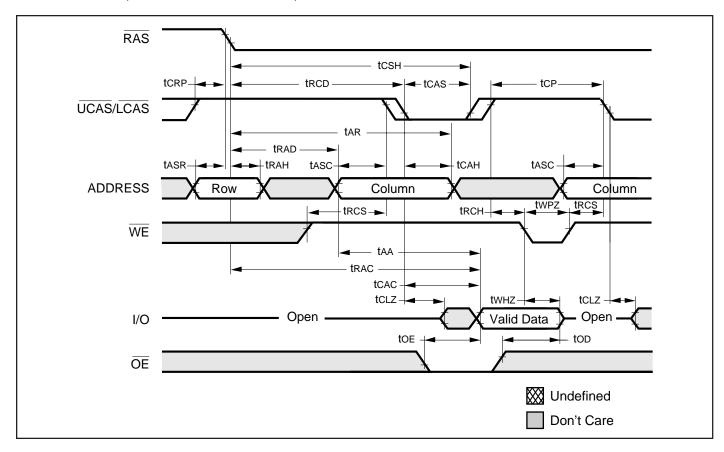
EDO-PAGE-MODE READ-EARLY-WRITE CYCLE (Psuedo READ-MODIFY WRITE)



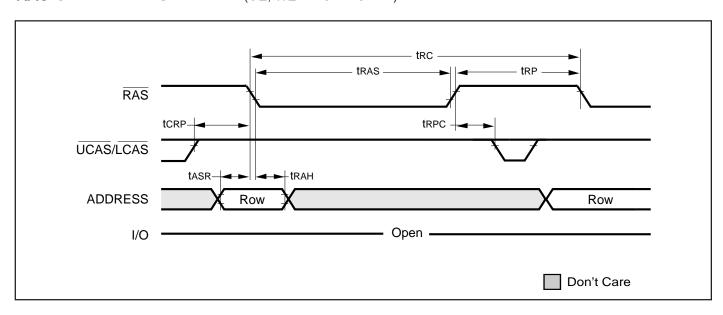


AC WAVEFORMS

READ CYCLE (With WE-Controlled Disable)

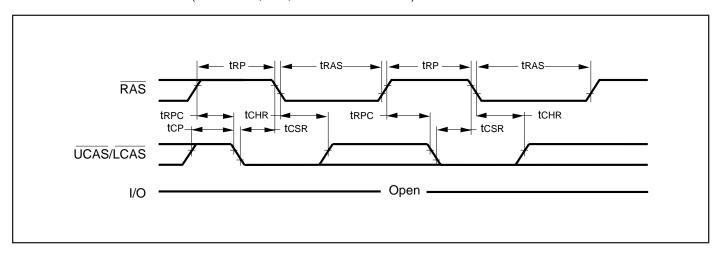


RAS-ONLY REFRESH CYCLE (OE, WE = DON'T CARE)

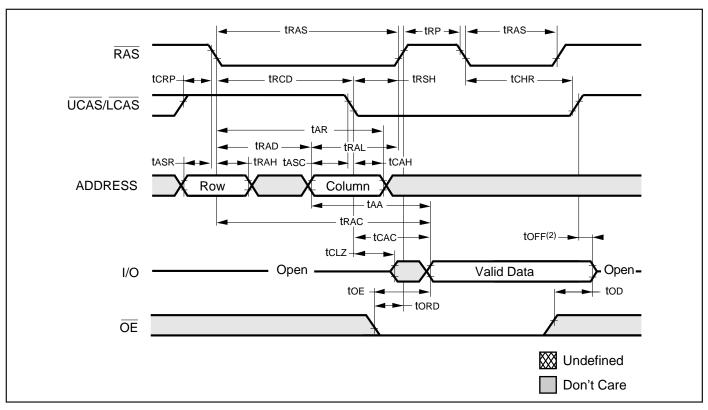




CBR REFRESH CYCLE (Addresses; WE, OE = DON'T CARE)



HIDDEN REFRESH CYCLE(1) (WE = HIGH; OE = LOW)



- A Hidden Refresh may also be performed after a Write Cycle. In this case, WE = LOW and OE = HIGH.
 toff is referenced from rising edge of RAS or CAS, whichever occurs last.



ORDERING INFORMATION IS41C16256

Commercial Range: 0°C to 70°C

ORDERING INFORMATION: IS41LV16256

Commercial Range: 0°C to 70°C

Speed (ns)	Order Part No.	Package	Speed (ns)	Order Part No.	Package
25	IS41C16256-25K IS41C16256-25T	400mil SOJ 400mil TSOP-2	35	IS41LV16256-35K IS41LV16256-35T	400mil SOJ 400mil TSOP-2
35	IS41C16256-35K IS41C16256-35T	400mil SOJ 400mil TSOP-2	50	IS41LV16256-50K IS41LV16256-50T	400mil SOJ 400mil TSOP-2
50	IS41C16256-50K IS41C16256-50T	400mil SOJ 400mil TSOP-2	60	IS41LV16256-60K IS41LV16256-60T	400mil SOJ 400mil TSOP-2
60	IS41C16256-60K IS41C16256-60T	400mil SOJ 400mil TSOP-2			

Industrial Range: -40°C to 85°C Industrial Range: -40°C to 85°C

Speed (ns)	Order Part No.	Package	Speed (ns) Order Part No.	Package
25	IS41C16256-25KI IS41C16256-25TI	400mil SOJ 400mil TSOP-2	35	IS41LV16256-35K IS41LV16256-35T	400mil SOJ 400mil TSOP-2
35	IS41C16256-35KI IS41C16256-35TI	400mil SOJ 400mil TSOP-2	50	IS41LV16256-50KI IS41LV16256-50TI	400mil SOJ 400mil TSOP-2
50	IS41C16256-50KI IS41C16256-50TI	400mil SOJ 400mil TSOP-2	60	IS41LV16256-60KI IS41LV16256-60TI	400mil SOJ 400mil TSOP-2
60	IS41C16256-60KI IS41C16256-60TI	400mil SOJ 400mil TSOP-2			





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